Complementary Silicon High-Power Transistors

Designed for general-purpose power amplifier and switching applications.

Features

- 25 A Collector Current
- Low Leakage Current
 - $\tilde{I}_{CEO} = 1.0 \text{ mA} @ 30 \text{ and } 60 \text{ V}$
- Excellent DC Gain
 - $h_{FE} = 40 \text{ Typ} @ 15 \text{ A}$
- High Current Gain Bandwidth Product $|h_{fe}| = 3.0 \text{ min } @ I_C$
 - = 1.0 A, f = 1.0 MHz
- These are Pb-Free Devices*

MAXIMUM RATINGS

Rating	Symbol	TIP35A TIP36A	TIP35B TIP36B	TIP35C TIP36C	Unit
Collector - Emitter Voltage	V_{CEO}	60	80	100	Vdc
Collector - Base Voltage	V _{CB}	60	80	100	Vdc
Emitter - Base Voltage	V _{EB}	5.0			Vdc
Collector Current – Continuous – Peak (Note 1)	Ι _C	25 40		Adc	
Base Current – Continuous	Ι _Β	5.0		Adc	
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D		125		W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150		°C	
Unclamped Inductive Load	E _{SB}	90		mJ	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.0	°C/W
Junction-To-Free-Air Thermal Resistance	$R_{\theta JA}$	35.7	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

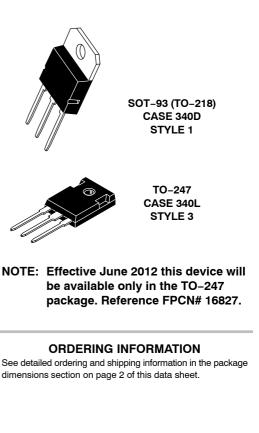
1. Pulse Test: Pulse Width = 10 ms, Duty Cycle \leq 10%.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

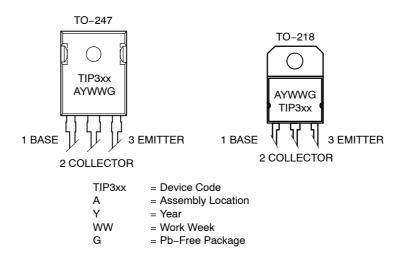
ON Semiconductor®

http://onsemi.com

25 AMPERE COMPLEMENTARY SILICON POWER TRANSISTORS 60–100 VOLTS, 125 WATTS



MARKING DIAGRAMS



ORDERING INFORMATION

Device	Package	Shipping	
TIP35AG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail	
TIP35BG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail	
TIP35CG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail	
TIP36AG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail	
TIP36BG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail	
TIP36CG	SOT-93 (TO-218) (Pb-Free)	30 Units / Rail	
TIP35AG	TO-247 (Pb-Free)	30 Units / Rail	
TIP35BG	TO-247 (Pb-Free)	30 Units / Rail	
TIP35CG	TO-247 (Pb-Free)	30 Units / Rail	
TIP36AG	TO-247 (Pb-Free)	30 Units / Rail	
TIP36BG	TO-247 (Pb-Free)	30 Units / Rail	
TIP36CG	TO-247 (Pb-Free)	30 Units / Rail	

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

Characteris	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					•
Collector–Emitter Sustaining Voltage (Note 2) $(I_C = 30 \text{ mA}, I_B = 0)$	TIP35A, TIP36A TIP35B, TIP36B TIP35C, TIP36C	V _{CEO(sus)}	60 80 100		Vdc
	TIP35A, TIP36A TIP35B, TIP35C, TIP36B, TIP36C	I _{CEO}		1.0 1.0	mA
Collector–Emitter Cutoff Current (V_{CE} = Rated V_{CEO} , V_{EB} = 0)		I _{CES}	-	0.7	mA
Emitter–Base Cutoff Current $(V_{EB} = 5.0 \text{ V}, I_C = 0)$		I _{EBO}	-	1.0	mA
ON CHARACTERISTICS (Note 2)					
DC Current Gain (I _C = 1.5 A, V _{CE} = 4.0 V) (I _C = 15 A, V _{CE} = 4.0 V)		h _{FE}	25 15	_ 75	_
Collector-Emitter Saturation Voltage ($I_C = 15 \text{ A}, I_B = 1.5 \text{ A}$) ($I_C = 25 \text{ A}, I_B = 5.0 \text{ A}$)		V _{CE(sat)}		1.8 4.0	Vdc
Base-Emitter On Voltage ($I_C = 15 \text{ A}, V_{CE} = 4.0 \text{ V}$) ($I_C = 25 \text{ A}, V_{CE} = 4.0 \text{ V}$)		V _{BE(on)}		2.0 4.0	Vdc
DYNAMIC CHARACTERISTICS			•		·
Small–Signal Current Gain (I _C = 1.0 A, V _{CE} = 10 V, f = 1.0 kHz)		h _{fe}	25	-	_
Current–Gain — Bandwidth Product ($I_C = 1.0 \text{ A}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ MHz}$)		f _T	3.0	-	MHz

2. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

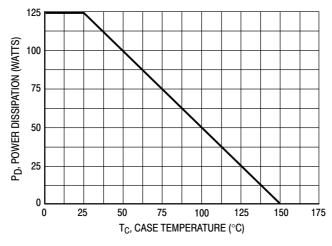
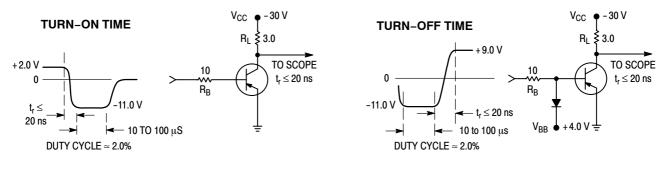


Figure 1. Power Derating



FOR CURVES OF FIGURES 3 & 4, R_B & R_L ARE VARIED. INPUT LEVELS ARE APPROXIMATELY AS SHOWN. FOR NPN, REVERSE ALL POLARITIES.



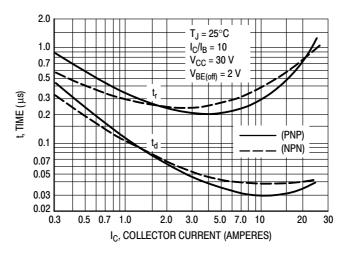
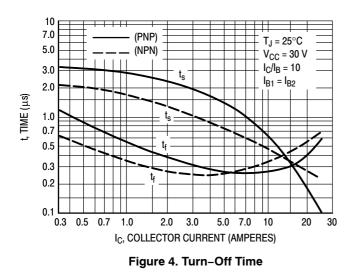


Figure 3. Turn-On Time



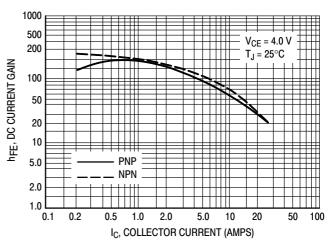


Figure 5. DC Current Gain

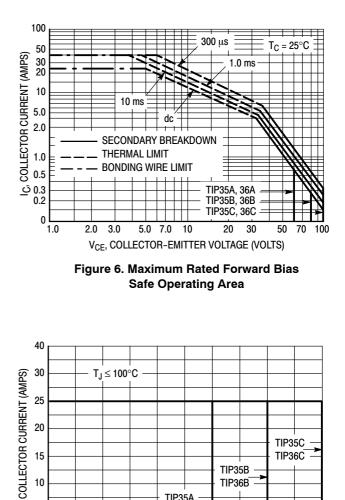
FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{C} - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations.

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 7 gives RBSOA characteristics.





50

V_{CE}, COLLECTOR-EMITTER VOLTAGE (VOLTS)

60

TIP35A

TIP36A

TIP35C TIP36C

90

100

TIP35B

TIP36B

70

80

15

10

0 0

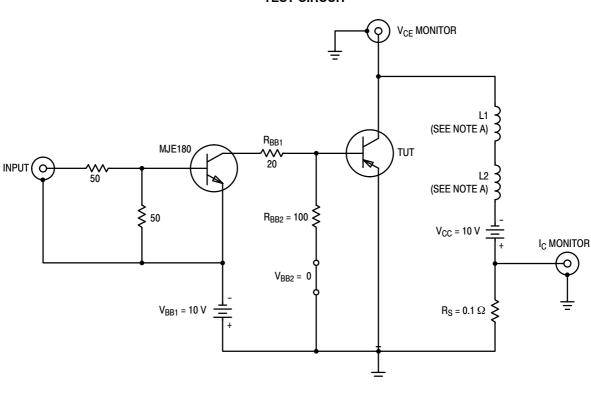
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20

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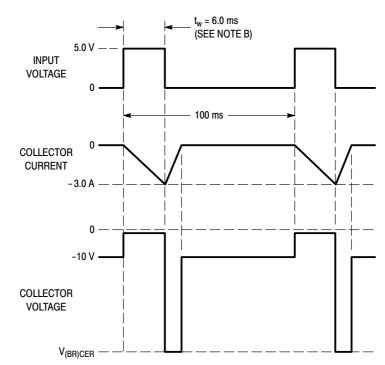
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5.0 ت



TEST CIRCUIT

VOLTAGE AND CURRENT WAVEFORMS

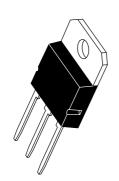


NOTES:

- A. L1 and L2 are 10 mH, 0.11 Ω , Chicago Standard Transformer Corporation C–2688, or equivalent.
- B. Input pulse width is increased until $I_{CM} = -3.0$ A.
- C. For NPN, reverse all polarities.

Figure 8. Inductive Load Switching

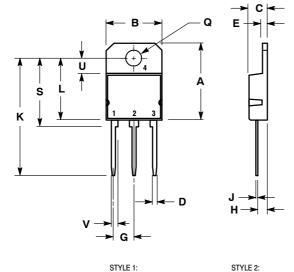




SOT-93 (TO-218) CASE 340D-02 **ISSUE E**

DATE 01/03/2002



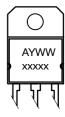


STYLE 1: PIN 1. BASE 2. COLLECTOR FMITTER 4. COLLECTOR

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α		20.35		0.801	
В	14.70	15.20	0.579	0.598	
C	4.70	4.90	0.185	0.193	
D	1.10	1.30	0.043	0.051	
Ε	1.17	1.37	0.046	0.054	
G	5.40	5.55	0.213	0.219	
Н	2.00	3.00	0.079	0.118	
J	0.50	0.78	0.020	0.031	
K	31.00 REF		1.220	.220 REF	
L		16.20		0.638	
Q	4.00	4.10	0.158	0.161	
S	17.80	18.20	0.701	0.717	
U	4.00 REF		0.157	0.157 REF	
۷	1.75 REF		0.069		

MARKING DIAGRAM



А = Assembly Location Y = Year WW = Work Week

= Device Code XXXXX

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PIN 1. ANODE 2. CATHODE

3. ANODE

4. CATHODE

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

onsemi

TO-247 CASE 340L ISSUE G

NUTES

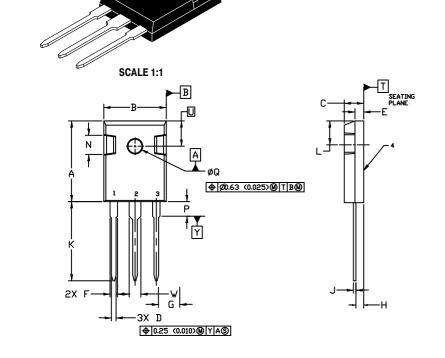
1.

2

W

2.87

DATE 06 OCT 2021



Y14.5M, 1982.					
CONTROLLING DIMENSION: MILLIMETER					
	MILLIMETERS		INC	HES	
DIM	MIN.	MAX.	MIN.	MAX.	
Α	20.32	21.08	0.800	0.830	
В	15.75	16.26	0.620	0.640	
С	4.70	5.30	0.185	0.209	
D	1.00	1.40	0.040	0.055	
E	1.90	2.60	0.075	0.102	
F	1.65	2.13	0.065	0.084	
G	5.45	5.45 BSC		BSC	
н	1.50	2.49	0.059	0.098	
J	0.40	0.80	0.016	0.031	
к	19.81	20.83	0.780	0.820	
L	5.40	6.20	0.212	0.244	
N	4.32	5.49	0.170	0.216	
Р		4.50		0.177	
Q	3.55	3.65	0.140	0.144	
U	6.15 BSC		0.242	BSC BSC	

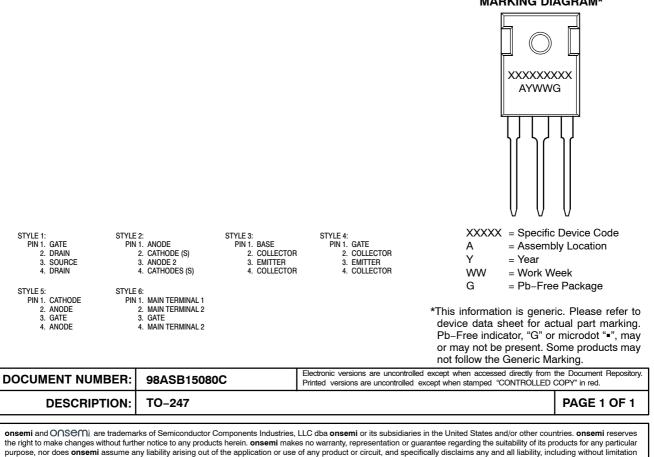
DIMENSIONING AND TOLERANCING PER ASME

GENERIC MARKING DIAGRAM*

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3.12



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